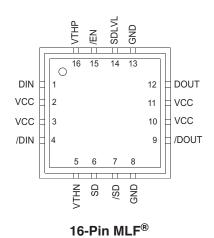
PACKAGE/ORDERING INFORMATION



Ordering Information

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY88953LMI	MLF-16	Industrial	953L	Sn-Pb
SY88953LMITR ⁽¹⁾	MLF-16	Industrial	953L	Sn-Pb
SY88953LMG	MLF-16	Industrial	953L with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY88953LMGTR ⁽¹⁾	MLF-16	Industrial	953L with Pb-Free bar-line indicator	Pb-Free NiPdAu

Note:

1. Tape and Reel.

PIN DESCRIPTION

Pin Number	Pin Name	Туре	Pin Function
1	DIN	Data Input	True data input w/50 Ω resistor to V _{CC} .
2, 3, 10, 11	VCC	Power Supply	Positive power supply.
4	/DIN	Data Input	Complementary data input w/50 Ω resistor to V _{CC} .
5	VTHN	Input	/DIN DC threshold adjustment pin.
6	SD	Open-collector TTL output w/ internal 5kΩ pull-up resistor	Signal-Detect: Asserts high when the data input amplitude rises above the threshold set by SD _{LVL} .
7	/SD	Open-collector TTL output w/ internal 5kΩ pull-up resistor	Inverted Signal-Detect: Asserts low when the data input amplitude rises above the threshold set by $\mathrm{SD}_{\mathrm{LVL}}$.
8, 13, EP	GND	Ground	Device ground. Exposed pad must be soldered to PCB ground for proper electrical and thermal performance.
9	/DOUT	CML Output	Complementary data output.
12	DOUT	CML Output	True data output.
14	SDLVL	Input	Signal-Detect Level Set: A resistor from this pin to V _{CC} sets the threshold for the data input amplitude at which SD will be asserted.
15	/EN	TTL Input: Default is high.	Enable: Deasserts true data output when high.
16	VTHP	Input	DIN DC threshold adjustement pin.

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V _{CC})	
Data Input Voltage (D _{IN} , /D _{IN}) (V _{CC} -	1.0V) to (V _{CC} +0.5V)
Data Output Voltage (D _{OUT} , /D _{OUT})	
(V _{CC} -	1.0V) to $(V_{CC} + 0.5V)$
Data Output Current (D _{OUT.} /D _{OUT})	22mA
/EN Voltage	
SD, /SD Current	5mA
SDLVL Voltage	$(V_{CC}-1.3V)$ to V_{CC}
Storage Temperature (T _S)	–65°C to +150°C

Operating Ratings⁽²⁾

Supply Voltage (V _{CC})	+3.0V to +3.6V
Ambient Temperature (T _A)	–40°C to +85°C
Junction Temperature (T _J)	40°C to +120°C
Package Thermal Resistance ⁽³⁾ MLF [®]	
(θ_{JA}) Still-Air	59°C/W
(ψ _{IB}) Still-Air	

DC ELECTRICAL CHARACTERISTICS

 V_{CC} = 3.0V to 3.6V; R_{LOAD} = 50 Ω to V_{CC} ; T_A = -40°C to +85°C; typical values at V_{CC} = 3.3V, T_A = 25°C

Symbol	Parameter	Condition	Min	Тур	Max	Units
I _{CC}	Power Supply Current	no output load		110	170	mA
V _{SDLVL}	SDLVL Voltage		V _{CC} -1.3		V _{CC}	V
V _{IH}	/EN Input HIGH Voltage		2.0			V
$V_{\rm IL}$	/EN Input LOW Voltage				0.8	V
I _{IH}	/EN Input HIGH Current	$V_{IN} = V_{CC}$			20	μΑ
I _{IL}	/EN Input LOW Current	V _{IN} = 0.5V	-0.3			mA
V _{OH}	SD, /SD Output HIGH Level		2.4			V
V_{OL}	SD, /SD Output LOW Level	I _{OL} = +2mA			0.5	V
V _{OH}	Output HIGH Voltage	50Ω to V_{CC} output load	V _{CC} -0.020	V _{CC} -0.005	V _{CC}	V
V_{OL}	Output LOW Voltage	50Ω to V_{CC} output load	V _{CC} -0.560	V _{CC} -0.400	V _{CC} -0.240	V
V _{OFFSET}	Differential Output Offset				±80	mV
Z_{O}	Single-Ended Output Impedance		40	50	60	Ω
Z _O	Single-Ended Input Impedance		40	50	60	Ω

Note s:

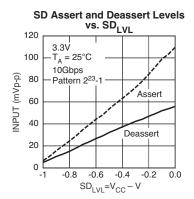
- 1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- 2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- 3. Exposed pad must be soldrered to PCB's ground plane.

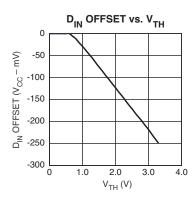
AC ELECTRICAL CHARACTERISTICS

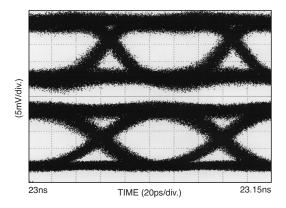
 $\rm V_{CC} = 3.0V~to~3.6V;~R_{LOAD} = 50\Omega~to~V_{CC};~T_A = -40^{\circ}C~to~+85^{\circ}C;~typical~values~at~V_{CC} = 3.3V,~T_A = 25^{\circ}C$

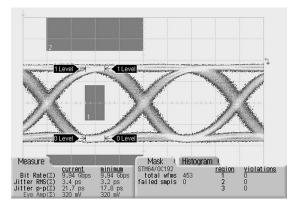
Symbol	Parameter	Condition	Min	Тур	Max	Units
HYS	SD Hysteresis	electrical signal	2	6	8	dB
PSRR	Power Supply Rejection Ratio			35		dB
t _{OFF}	SD, /SD Release Time			0.1	0.5	μS
t _{ON}	SD, /SD Assert Time			0.2	0.5	μS
t _r ,t _f	Output Rise/Fall Time	$V_{ID} \ge 50 \text{mV}_{PP}$		30	35	ps
V_{ID}	Differential Input Voltage Swing		5		1800	mV _{PP}
V _{OD}	Differential Output Voltage Swing		480	800	1120	mV _{PP}
V_{SR}	SD Sensitivity Range		5		50	mV _{PP}
A _{V(Diff)}	Differential Voltage Gain		22	28		dB
S ₂₁	Single-Ended Small-Signal Gain		16	22		dB
B _{-3dB}	3dB Bandwidth			7.5		GHz

TYPICAL OPERATING CHARACTERISTICS









(3.3V, 27°C, 10Gbps) 30mV_{PP} Differential Input

DETAILED DESCRIPTION

The SY88953L high-speed limiting post amplifier operates from a single +3.3V power supply, over temperatures from -40°C to +85°C. Signals with data rates up to 10.7Gbps and as small as 5mVp-p can be amplified. Figure 1 shows the allowed input voltage swing. The SY88953L generates SD and /SD outputs. SD_{LVL} sets the sensitivity of the input amplitude detection. The SY88953L also includes an input threshold adjustment to correct pulsewidth distortion

Input Amplifier/Buffer

Figure 2 shows a simplified schematic of the SY88953L's input stage. The high-sensitivity of the input amplifier allows signals as small as 5mVp-p to be detected and amplified. The input amplifier allows input signals as large as 1800mVp-p. Input signals are linearly amplified with a typically 28dB differential voltage gain. Since it is a limiting amplifier, the SY88953L outputs typically 800mVp-p voltage-limited waveforms for input signals that are greater than 32mVp-p. Applications requiring the SY88953L to operate with highgain should have the upstream TIA placed as close as possible to the SY88953L's input pins to ensure the best performance of the device.

Threshold Adjustment

The SY88953L's duty cycle can be controlled by forcing an offset at either input using V_{THP} or $V_{THN}.$ Typically, only one of the inputs is required to be adjusted, depending on the required direction of the pulse width adjustment. The SY88953L implements current source based offset control of the inputs. "Typical Operating Characteristics" shows the offset applied to the input for a given V_{TH} voltage. This feature is disabled by simply setting V_{TH} to GND.

Output Buffer

The SY88953L's CML output buffer is designed to drive 50Ω lines. The output buffer requires appropriate termination for proper operation. An external 50Ω resistor to V_{CC} for each output pin provides this. Figure 3 shows a simplified schematic of the output stage and includes an appropriate termination method. Of course, driving a downstream device that is internally terminated with 50Ω to V_{CC} eliminates the need for external termination. As noted in the previous section, the amplifier outputs typically 800mVp-p waveforms across 25Ω total loads. The output buffer thus switches typically 16mA tail-current.

Signal-Detect

The SY88953L generates chatter-free signal-detect (SD and /SD) open-collector TTL outputs with internal $5\mathrm{k}\Omega$ pullup resistors as shown in Figure 4. SD is used to determine that the input amplitude is large enough to be considered a valid input. SD asserts high if the input amplitude rises above the threshold set by $\mathrm{SD}_{\mathrm{LVL}}$ and deasserts low otherwise. /SD is the complementary output of SD. /SD asserts low if the input amplitude rises above the threshold set by $\mathrm{SD}_{\mathrm{LVL}}$ and deasserts high otherwise. /SD can be fed back to the enable (/EN) input to maintain output stability under a loss of signal condition. /EN deasserts the true output signal without removing the input signals. Typically 6dB SD hysteresis is provided to prevent chattering.

Signal-Detect Level Set

A programmable signal-detect level set pin (SD_{LVL}) sets the threshold of the input amplitude detection. Connecting an external resistor between V_{CC} and SD_{LVL} sets the voltage at SD_{LVL} . This voltages ranges from V_{CC} to $V_{CC}\text{-}1.3V$. The external resistor creates a voltage divider between V_{CC} and $V_{CC}\text{-}1.3V$ as shown in Figure 5. If desired, an appropriate external voltage may be applied rather than using a resistor. The smaller the external resistor, implying a smaller voltage difference from SD_{LVL} to V_{CC} , the smaller the SD sensitivity. Hence, larger input amplitude is required to assert SD. "Typical Operating Characteristics" shows the relationship between the input amplitude detection sensitivity and the SD_{LVL} voltage.

Hysteresis

The SY88953L provides typically 6dB SD electrical hysteresis. By definition, a power ratio measured in dB is 10log(power ratio). Power is calculated as V²_{IN}/R for an electrical signal. Hence the same ratio can be stated as 20log(voltage ratio). While in linear mode, the electrical voltage input changes linearly with the optical power and hence the ratios change linearly. Therefore, the optical hysteresis in dB is half the electrical hysteresis in dB given in the datasheet. The SY88953L provides typically 3dB SD optical hysteresis. As the SY88953L is an electrical device, this datasheet refers to hysteresis in electrical terms. With 6dB SD hysteresis, a voltage factor of two is required to assert or deassert SD.

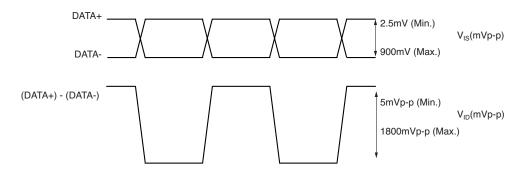


Figure 1. V_{IS} and V_{ID} Definitions

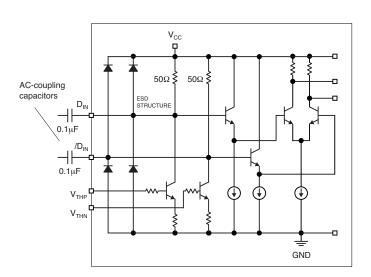


Figure 2. Input Structure

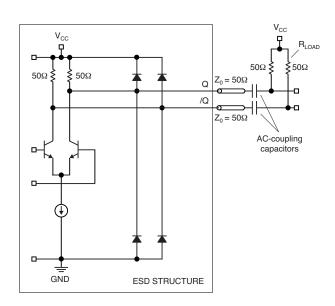


Figure 3. Output Structure

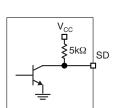


Figure 4. SD, /SD Output Structure

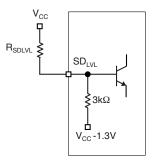
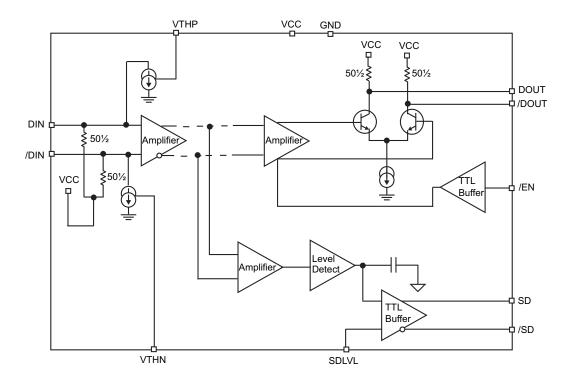


Figure 5. SD_{LVL} Setting Circuit

FUNCTIONAL BLOCK DIAGRAM



DESIGN PROCEDURE

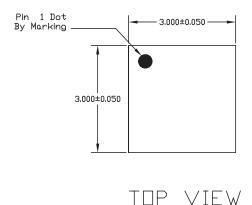
Layout and PCB Design

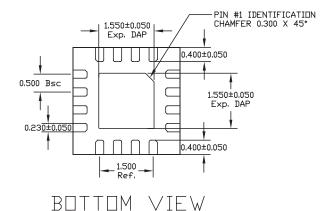
Since the SY88953L is a high-frequency component, performance can be largely determined by the board layout and design. A common problem with high-gain amplifiers is the feedback from the large swing outputs to the input via the power supply.

The SY88953L's ground pins should be connected to the circuit board ground. Use multiple PCB vias close to the part to connect to ground. Avoid long, inductive runs which can degrade performance.

SY88953L Micrel, Inc.

16-PIN MicroLeadFrame® (MLF-16)





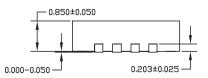
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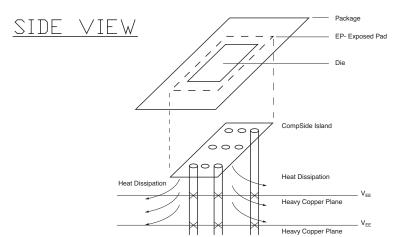
- 1.
- ALL DIMENSIONS ARE IN MILLIMETERS.

 MAX. PACKAGE WARPAGE IS 0.05 mm.

 MAXIMUM ALLOWABE BURRS IS 0.076 mm IN ALL DIRECTIONS.

 PIN #1 ID ON TOP WILL BE LASER/INK MARKED.





PCB Thermal Consideration for 16-Pin MLF® Package (Always solder, or equivalent, the exposed pad to the PCB)

Package Notes:

- 1. Package meets Level 2 qualification.
- 2. All parts are 100% baked and dry-packaged before shipment.
- 3. Exposed pads must be soldered to a ground for proper thermal management.

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